



an Open Access Journal by MDPI

# **Advanced Biomaterials in Bone Defect Healing**

Guest Editor:

## Prof. Charles C Lee

Department of Cell Biology and Human Anatomy, School of Medicine, University of California, Davis, CA 95616, USA

Deadline for manuscript submissions: closed (16 August 2021)

### Message from the Guest Editor

Dear Colleagues,

Biomaterials play a crucial role in regeneration and repair of bone, especially when the size of a defect extends beyond the body's ability to heal spontaneously. This Special Issue will bring together papers that focus on biomaterials designed and developed to address issues surrounding repair and regeneration of bone including but not limited to the following:

- Design, development, and fabrication of novel scaffolds or biomaterials for bone healing;
- Fate of resident or transplanted stem and progenitor cells in scaffolds after implantation;
- In vivo imaging of biomaterials or scaffolds during bone healing;
- Preclinical and clinical studies on biomaterials for bone repair and regeneration;
- Mechanical properties of various biomaterials specifically designed for bone repair and regeneration;
- Role of biomaterials and scaffolds in the reconstitution of damaged bone microenvironment;

Special Issue Link: https://www.mdpi.com/journal/applsci/special\_issues/ Biomaterials\_Bone\_Healing









an Open Access Journal by MDPI

### **Editor-in-Chief**

#### Message from the Editor-in-Chief

**Prof. Dr. Giulio Nicola Cerullo** Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

### **Author Benefits**

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.
High Visibility: indexed within Scopus, SCIE (Web of Science), Inspec, CAPlus / SciFinder, and other databases.
Journal Rank: JCR - Q2 (*Engineering, Multidisciplinary*) / CiteScore - Q1 (*General Engineering*)

### **Contact Us**

Applied Sciences Editorial Office MDPI, St. Alban-Anlage 66 4052 Basel, Switzerland Tel: +41 61 683 77 34 www.mdpi.com mdpi.com/journal/applsci applsci@mdpi.com X@Applsci